

105TH CONGRESS  
2D SESSION

# H. R. 3374

To amend the harmonized Tariff Schedule of the United States to provide for temporary duty-free treatment for semiconductor plating lines.

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## IN THE HOUSE OF REPRESENTATIVES

MARCH 5, 1998

Mr. CRAPO introduced the following bill; which was referred to the Committee on Ways and Means

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## A BILL

To amend the Harmonized Tariff Schedule of the United States to provide for temporary duty-free treatment for semiconductor plating lines.

1       *Be it enacted by the Senate and House of Representa-*  
2       *tives of the United States of America in Congress assembled,*

3       **SECTION 1. TEMPORARY SUSPENSION OF DUTY ON SEMI-**  
4       **CONDUCTOR PLATING LINES.**

5       (a) IN GENERAL.—Subchapter II of chapter 99 of  
6       the Harmonized Tariff Schedule of the United States is  
7       amended by inserting in numerical sequence the following  
8       new heading:

“	9902.85.43	Plating lines for semiconductors and integrated circuits (provided for in subheading 8543.30.0000) .....	Free	No change	No change	On or before 12/31/01	”.
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1           (b) **EFFECTIVE DATE.**—The amendment made by  
2 subsection (a) applies with respect to goods entered, or  
3 withdrawn from warehouse for consumption, on or after  
4 the 15th day after enactment of this Act.

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